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Disconnect System Power Cables

Disconnect the attached power cords, telecommunications systems, networks, and modems before you open or service the device.

장치를 열거나 서비스하기 전에 연결된 전원 코드, 통신 시스템, 네트워크 및 모뎀의 연결을 해제해야 합니다.

在開啟或保養裝置前，請將所有電源線、電信系統、網路與數據機全部拔除。

Отключите подключенные шнуры питания, телекоммуникационные системы, сети и модемы, прежде чем открывать или обслуживать устройство.
Remove Top Cover/Fan Assembly
Remove Left Side Panel
Remove Cross Bar Bracket
Fold Air Guide Back
Open Quartz Canyon Door
Install Memory into Quartz Canyon
Install M.2 Module(s) into Quartz Canyon

1. Locate the M.2 module slots (A).
2. Align the M.2 module with the slots (B).
3. Ensure proper orientation (C).
4. Insert the M.2 module into the slots (D).
5. Secure with screws (E).
Close Quartz Canyon Door and Fold Air Guide Into Place
Install Add-In Card

M.2 Slot
PCle x16
PCle x4

A

C

B

D

OR
Install Cross Bar Bracket
Install Left Side Panel
Install Top Cover/Fan Assembly and Apply Power Cable.

All chassis exterior panels must be installed before power is applied to the chassis.

장치에 전원을 공급하기 전에 모든 새시 외장 패널을 설치해야 합니다.

將裝置接上電源前, 所有機殼外部面板必須安裝完成。

Все внешние панели корпуса должны быть установлены до подачи питания на устройство.
Install M.2 onto Baseboard
Remove Right Side Panel and Rear Retention Screw
Install M.2 onto Baseboard
Disconnect Audio, Antenna, Type-C, and EPS Power Connections
Install M.2 onto Baseboard
Disconnect Front Panel and Aux Fan, Remove Quartz Canyon
Install M.2 onto Baseboard
Remove M.2 Heatsink From Baseboard
Install M.2 onto Baseboard

110 mm
80 mm
42 mm
M.2 Slot
Install M.2 onto Baseboard
Reinstall M.2 Heatsink onto Baseboard
Install M.2 onto Baseboard
Reinstall Quartz Canyon and Connect Front Panel and Aux Fan
Install M.2 onto Baseboard
Reconnect Audio, Antenna, Type-C, and GPU Power Connections
Install M.2 onto Baseboard
Fold Air Guide Into Place
Powering the System

All chassis exterior panels must be installed before power is applied to the chassis.
장치에 전원을 공급하기 전에 모든 새시 외장 패널을 설치해야 합니다.
將裝置接上電源前，所有機殼外部面板必須安裝完成。
 Все внешние панели корпуса должны быть установлены до подачи питания на устройство.
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